

PLEDxUSWxA Series - Unidirectional, White Body



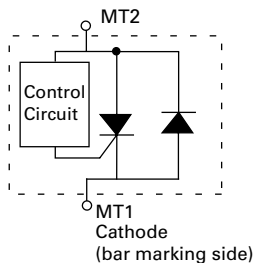
OBSOLETE DATE: 03/26/2020 PCN/ECN# 41325
REPLACED BY: PLEDxUSxA series



Agency Approvals

| Agency | Agency File Number |
|--------|--------------------|
| | E133083 |

Schematic Symbol



Description

PLEDxUSWxA open LED protectors provide a switching electronic shunt path when an LED in an electronic switching fails as an open circuit. This ensures that the remaining string of LEDs will continue to function if a single LED does not.

The device is designed to enable higher reliability in indoor LED lighting applications such as advertisement lighting and other applications. Additionally, it is molded from white material to make them less visible in the LED fixture and the white molding also reflects more light to improve overall light engine efficiency.

This series is compatible with one, two and three watt LEDs that have a nominal 3V forward characteristic and is available in an SMB, PLEDxUSWxA is available in SMB surface mount package. The DO-214AA (SMB) low profile package is ideal for dense board applications.

Features & Benefits

- Ideal for protecting high brightness LED with high operating current at specified condition.
- White compound for better optical appearances
- Fast switching
- Reverse Battery/Power Protection
- Low profile, small foot print standard DO-214AA package
- Compatible with industrial lighting environments
- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- Compatible with PWM frequencies up to 30 kHz
- RoHS compliant and halogen-free
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)


Electrical Characteristics (All parameters are measured at T=25°C unless otherwise noted)

| Part Number | Marking | V_{BR} breakdown | | V_{DRM} breakdown | I_H | I_S | $I_T @ V_T$ | $V_T @ I_T = 1 \text{ Amp}$ | I_O^1 | Critical rate of rise dV/dt |
|-------------|---------|--------------------|-----|---------------------|-------|-------|-------------|-----------------------------|---------|-----------------------------|
| | | Volts | | Volts | mAmps | mAmps | Amps | Volts | Amps | Volts |
| | | Min | Max | Min | Min | Max | Max | Max | Max | Max |
| PLED6USW2A | PL62A | 6 | 16 | 6 | 5 | 100 | 1.0 | 1.2 | 2 | 250V/μs |
| PLED6USW3A | PL63A | 6 | 16 | 6 | 5 | 100 | 1.0 | 1.2 | 3 | 250V/μs |
| PLED9USW3A | PL93A | 9 | 18 | 9 | 5 | 100 | 1.0 | 1.2 | 3 | 250V/μs |

Notes:

1. I_O - Operation current tested @ aluminum boards, ambient temp 85°C

Thermal Considerations

| Package | Symbol | Parameter | Value | Unit |
|--|-----------------|---|--|------|
| DO-214AA in White  | T_J | Operating Junction Temperature Range | -40 to +150 | °C |
| | T_S | Storage Temperature Range | -65 to +150 | °C |
| | $R_{\theta JA}$ | Thermal Resistance: Junction to Ambient | DO-214AA: 90 ¹ DO-214AA: 40 ² | °C/W |

Notes:

1) Standard FR-4 PCB with Copper Pads (Recommended Size)

2) Aluminum PCB

Thickness: 1.6mm

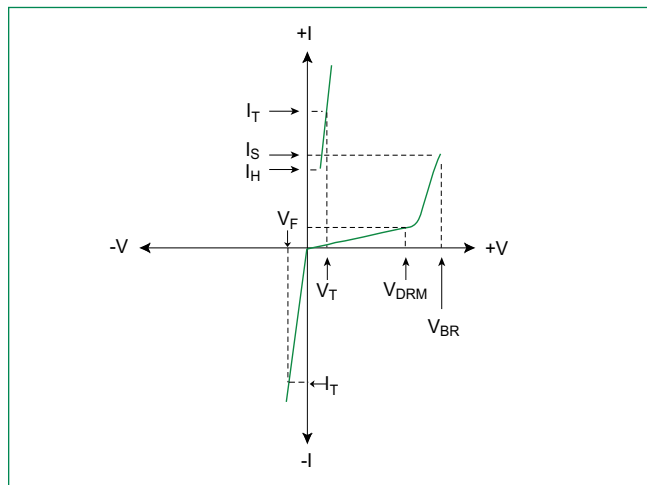
Grade: 1-2 W/mK Thermal Conductivity

Trace thickness: 2 oz

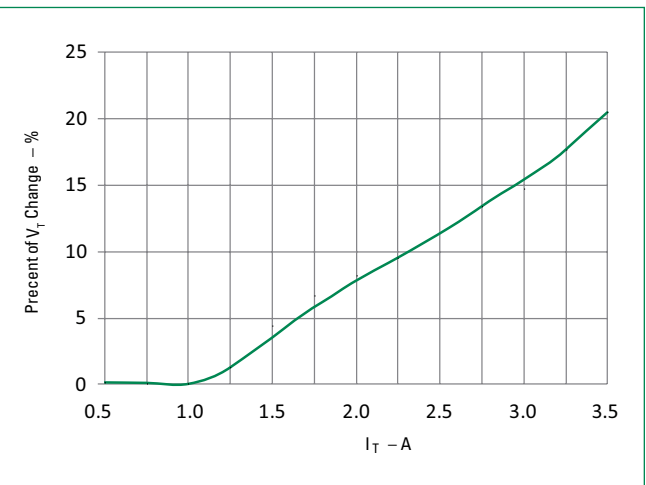
Insulation layer thickness: 215 um

Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

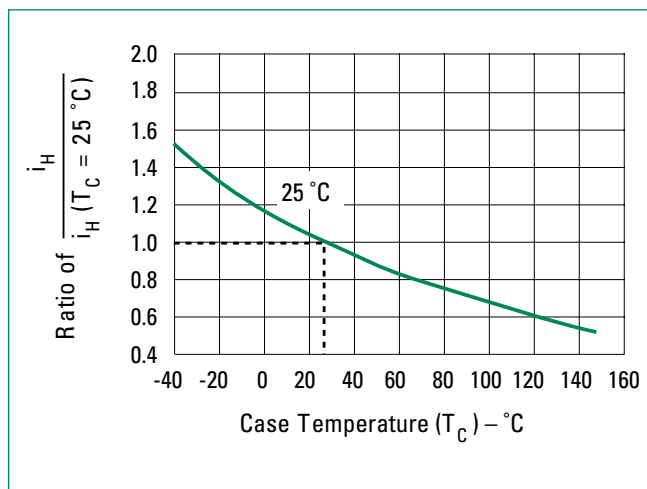
V-I Characteristics



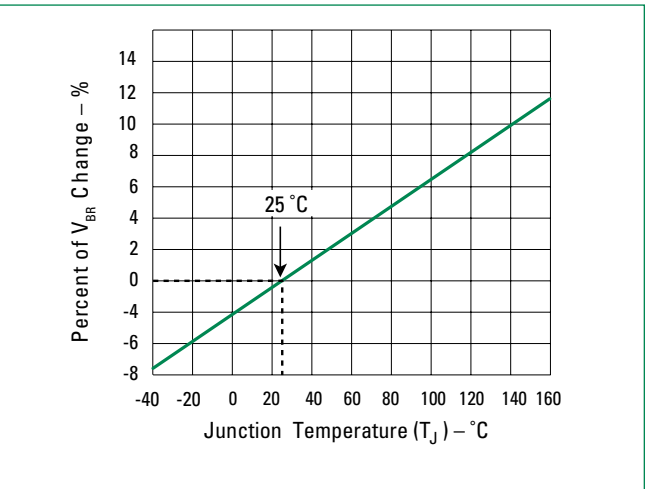
V_T vs. I_T



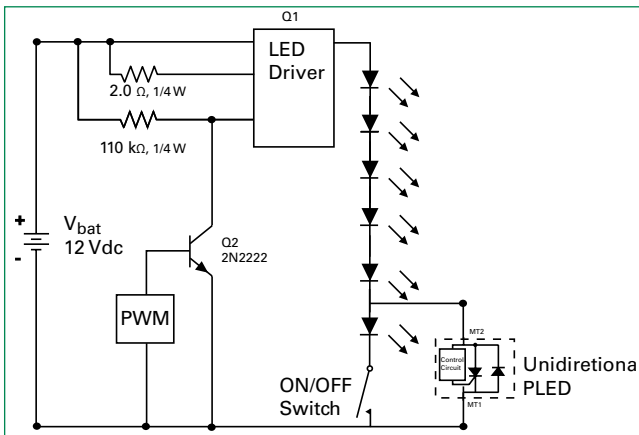
Normalized DC Holding Current vs. Case Temperature



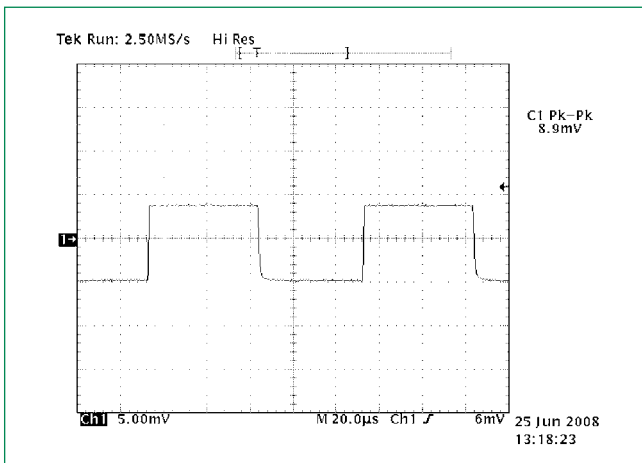
V_{BR} vs. Junction Temperature



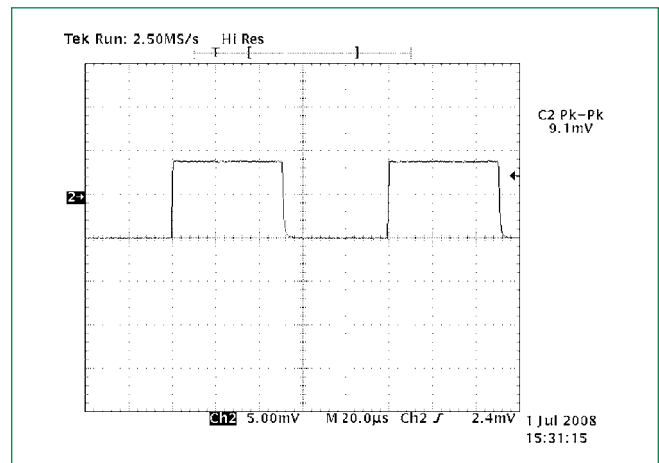
LED Interference Test Circuit



6 LEDs in Series 50% Duty Cycle 10kHz

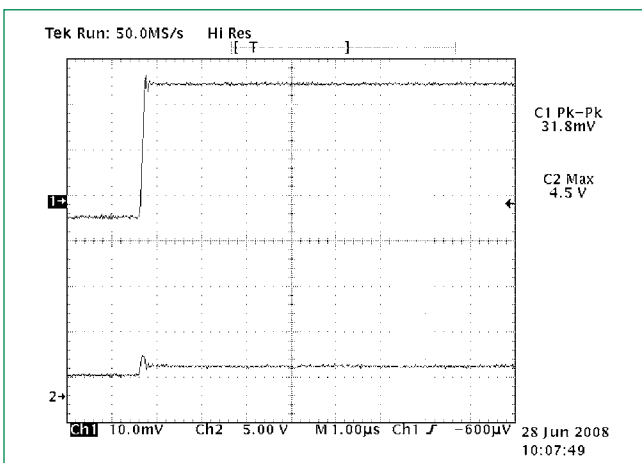


5 LEDs and 1 PLED in Series 50% Duty Cycle 10kHz



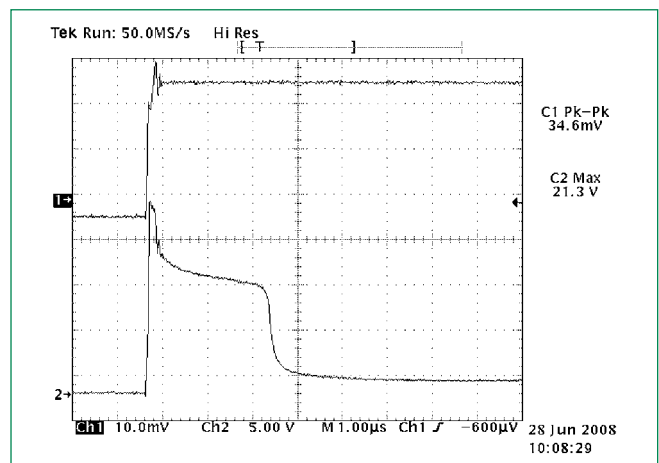
Note: These two graphs show the current magnitude through the LED string with and without the PLED included. There is no noticeable effect on the LED current magnitude when the PLED is included in the circuit as compared to the LED current magnitude when the PLED is not in the circuit. (The conversion factor for the test measurement in the graphs above is 10mA/mV for the Pearson coil measurement, therefore, the current magnitude in the first figure is 10mA*8.9 = 89mA, while the second figure is 91mA.)

PLED in the Off-State 10kHz



Channel 1: current through LEDs (318 mA)
Channel 2: voltage across PLED device (4.5 V)

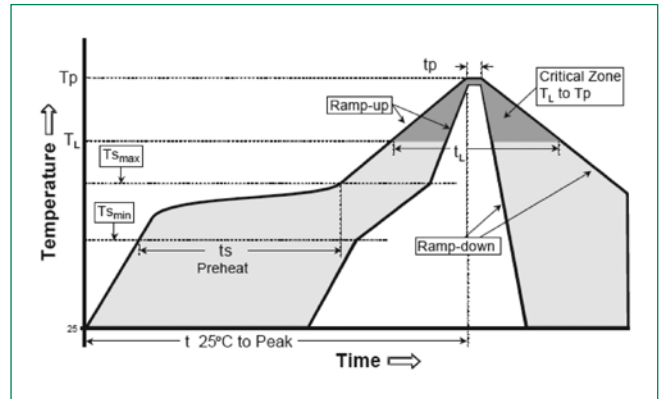
PLED device zeners and then turns fully on 10kHz



Channel 1: current through LEDs (346 mA) and PLED device once it is fully turned on 2.5 μsec later
Channel 2: voltage across PLED device (21.3 V before PLED crowbars with 2 V drop)

Soldering Parameters

| | | |
|--|------------------------------------|-------------------------|
| Reflow Condition | | Pb – Free assembly |
| Pre Heat | - Temperature Min ($T_{s(min)}$) | 150°C |
| | - Temperature Max ($T_{s(max)}$) | 200°C |
| | - Time (min to max) (t_s) | 60 – 180 secs |
| Average ramp up rate (Liquidus Temp (T_L) to peak) | | 3°C/second max |
| $T_{s(max)}$ to T_L - Ramp-up Rate | | 3°C/second max |
| Reflow | - Temperature (T_L) (Liquidus) | 217°C |
| | - Temperature (T_L) | 60 – 150 seconds |
| Peak Temperature (T_p) | | 260 ^{+0/-5} °C |
| Time within 5°C of actual peak Temperature (t_p) | | 30 seconds |
| Ramp-down Rate | | 6°C/second max |
| Time 25°C to peak Temperature (T_p) | | 8 minutes max |
| Do not exceed | | 260°C |



Physical Specifications

| | |
|--------------------------|--|
| Terminal Material | Copper Alloy |
| Terminal Finish | 100% Matte Tin Plated |
| Body Material | UL recognized compound meeting flammability classification V-0 |

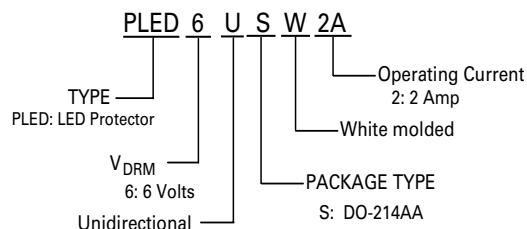
Environmental Specifications

| | |
|--|---|
| High Temperature Voltage Blocking | MIL-STD-750: Method 1040, Condition A 80% min V_{DRM} (VAC-peak), 150°C, 504 hours |
| Temperature Cycling | MIL-STD-750: Method 1051 -65°C to 150°C, 15-minute dwell, 100 cycles |
| Biased Temperature & Humidity | EIA/JEDEC: JESD22-A101 80% V_{DRM} , 85°C, 85% RH, 1008 hours |
| High Temperature Storage | MIL-STD-750: Method 1031 150°C, 1008 hours |
| Low Temperature Storage | -65°C, 1008 hours |
| Thermal Shock | MIL-STD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles |
| Resistance to Solder Heat | MIL-STD-750: Method 2031 260°C, 10 seconds |

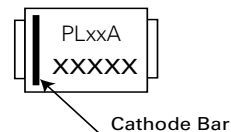
Packaging

| Package | Description | Packaging Quantity | Industry Standard |
|---------|-------------|--------------------|-------------------|
| S | DO-214AA | 2500 | EIA-481-1 |

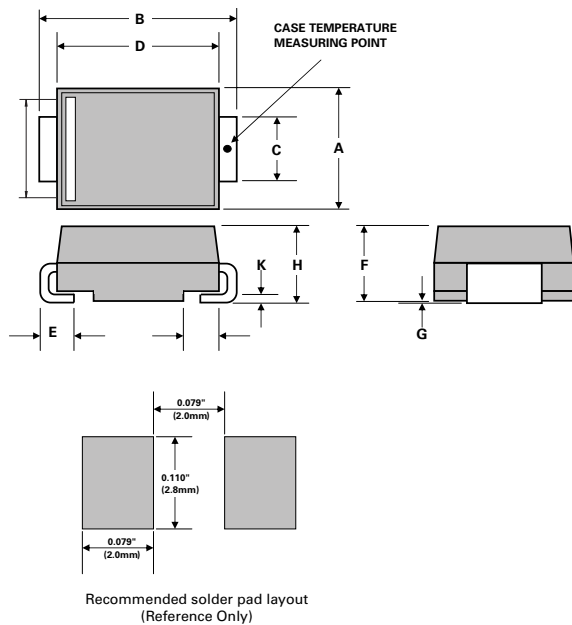
Part Numbering System



Part Marking System



Dimensions - DO-214 AA Package



| Dimensions | Inches | | Millimeters | |
|------------|--------|-------|-------------|------|
| | Min | Max | Min | Max |
| A | 0.130 | 0.156 | 3.30 | 3.95 |
| B | 0.201 | 0.220 | 5.10 | 5.60 |
| C | 0.077 | 0.087 | 1.95 | 2.20 |
| D | 0.159 | 0.181 | 4.05 | 4.60 |
| E | 0.030 | 0.063 | 0.75 | 1.60 |
| F | 0.075 | 0.096 | 1.90 | 2.45 |
| G | 0.002 | 0.008 | 0.05 | 0.20 |
| H | 0.077 | 0.104 | 1.95 | 2.65 |
| K | 0.006 | 0.016 | 0.15 | 0.41 |

DO-214AA Embossed Carrier Reel Pack (RP)

Meets all EIA-481-1 Standards

